

Design Example Report

Title	15W power supply using TNY268P				
Specification	Input: 120 - 420 Vdc Output: 5V/3A, 13V/10mA				
Application	PC Standby				
Author	Power Integrations Applications Department				
Document Number	DER-11				
Date	February 4, 2004				
Revision	1.0				

Summary and Features

This report details the design of an isolated Flyback converter for a PC Standby power supply.

- High light load efficiency
- Over 0.4W out at 1W in, as measured in the PC PSU
- Total output power 15 W with TNY268P and EE19 core
- Typical Efficiency 79 %
- Meets \pm 5 % output voltage regulation over line and load changes

The products and applications illustrated herein (including circuits external to the products and transformer construction) may be covered by one or more U.S. and foreign patents or potentially by pending U.S. and foreign patent applications assigned to Power Integrations. A complete list of Power Integrations' patents may be found at www.powerint.com

Power Integrations 5245 Hellyer Avenue, San Jose, CA 95138 USA. Applications Hotline: Tel: +1 408 414 9660 Fax: +1 408 414 9760 www.powerint.com

Table Of Contents

1	Intro	oduction	4
2	Pow	ver Supply Specification	
3	Sch	ematic	6
4	PCE	3 Layout	7
5	Bill	Of Materials	8
6	Trai	nsformer	9
6	.1	Transformer Winding	9
6	.2	Electrical Specifications	9
6	.3	Transformer Construction	10
6	.4	Materials	10
6	.5	Winding Instructions	11
6	.6	Design Notes:	11
7	Trai	nsformer Design Spread Sheet	12
Per	form	ance Data	14
7.	.1	Light Load Input and Output Power Comparison	
7	.2	Efficiency comparison, standalone	16
8	Out	put Ripple Measurements	17
8	.1	Ripple Measurement Technique	17
8	.2	Output Voltage Ripple	18
9	Rev	ision History	18
Not	es		19



List Of Figures

Figure 1 – Power Supply Prototype – Top View	4
Figure 2 – Power Supply Prototype – Bottom View	4
Figure 3 – TNY268 Flyback Converter – 15 W, 5V 3A, 13V 10 mA	
Figure 4 – PCB Layout	7
Figure 5 – Transformer Winding	9
Figure 6 – Transformer Construction	
Figure 7 – Input vs. Output power at 115 Vac	15
Figure 8 – Input vs. Output power at 230 Vac	15
Figure 9 – Efficiency versus output current at 115 Vac	
Figure 10 – Efficiency versus output current at 230 Vac	
Figure 11 – Oscilloscope Probe Prepared for Ripple Measurement	
Figure 12 – Oscilloscope Probe with Probe Master 5125BA BNC Adapter	
Figure 13 – 5V Output Voltage Ripple at V_{IN} = 115 Vac, I_{5V} = 3 A	

List Of Tables

Table 1 – Power Supply Specification	5
Table 2 – Bill of Materials	8
Table 3 – Transformer Electrical Parameters	9
Table 4 – Transformer BOM	10
Table 5 – Power Supply Design Parameters	11

Important Notes:

Although the prototype hardware is designed to satisfy safety isolation requirements, this engineering prototype has not been agency approved. Therefore all testing should be performed using an isolation transformer to provide the AC input to the prototype board.

The layout shown in this report has been engineered to follow Power Integrations' design guidelines to minimize EMI and susceptibility. Changing the layout may worsen EMI and other aspects of performance.

Design Reports contain a power supply design specification, schematic, bill of materials, and transformer documentation. Performance data and typical operation characteristics are included. Typically only a single prototype has been built.



1 Introduction

This document is an engineering report showing the performance characteristics of a 15W Flyback converter with 120–420Vdc (PFC application) input, 5V 3A isolated output, and 13V 10mA non-isolated output. This design uses *TinySwitch-II* – an integrated IC comprising a high voltage *MOSFET*, and *PWM* controller.

This document contains power supply specification, schematic, bill of materials, transformer documentation, printed circuit layout, and performance data. The photos of power supply prototype are shown in Figure 1 and Figure 2.

Measurements were taken both with the prototype standalone, and in the PC power supply.

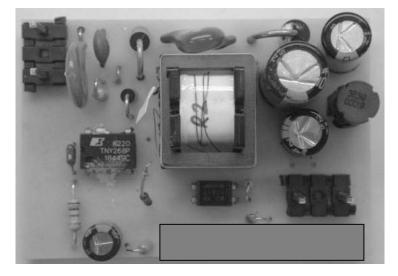


Figure 1 – Power Supply Prototype – Top View

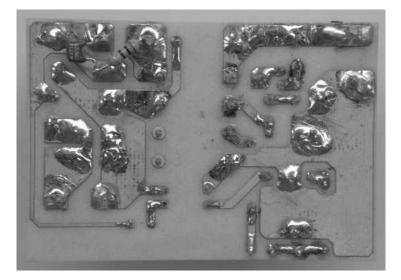


Figure 2 – Power Supply Prototype – Bottom View





Note: Y-cap is for testing the unit standalone. Otherwise, The common-mode noise may affect the input power measurements.

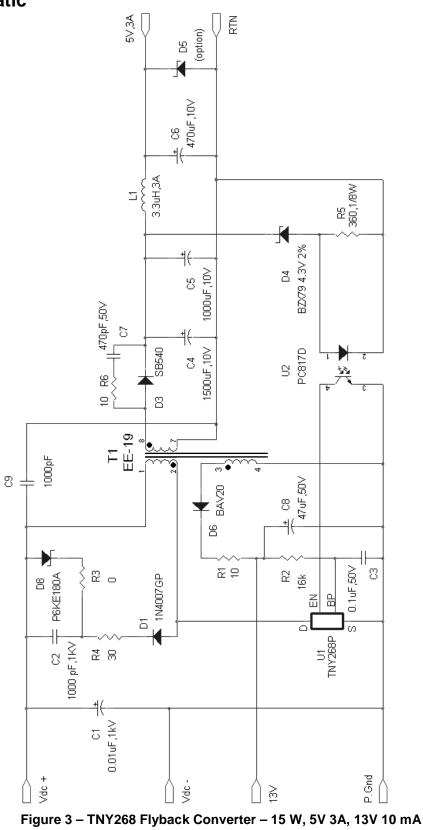
2 Power Supply Specification

Description	Symbol	Min	Тур	Max	Units	Comment
Input						
Voltage	V _{IN}	120		420	Vdc	PFC Standby
Outputs						
Output Voltage 1	V _{OUT1}	4.75	5.0	5.25	V	± 5%
Output Ripple Voltage 1	V _{RIPPLE1}			50	mV	20 MHz Bandwidth
Output Current 1	I _{OUT1}			3	А	isolated
Output Voltage 2	V _{OUT2}		13		V	
Output Ripple Voltage 2	V _{RIPPLE2}			130	mV	20 MHz Bandwidth
Output Current 2	I _{OUT2}			10	mA	non-isolated
Continuous Output Power	P _{out}		15		W	
Efficiency	η		79		%	At full load
Ambient Temperature	Т _{АМВ}	0		40	°C	Free convection, Sea level

Table 1 – Power Supply Specification



3 Schematic



Tel: +1 408 414 9660 Fax: +1 408 414 9760 www.powerint.com

4 PCB Layout

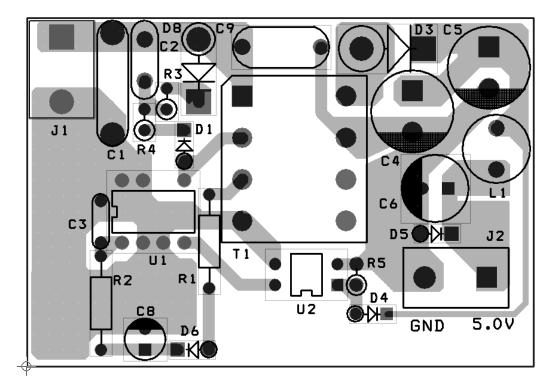


Figure 4 – PCB Layout

Note:

- 1. The schematic and PCB layout have some components as OPTIONS, which are not used in the prototype.
- 2. The prototype PCB layout may not match the schematic, due to modifications made to meet the specifications.



5 Bill Of Materials

Item	Qty	Reference	Description				
1	1	C1	0.01 μF, 1KV, Ceramic capacitor, Z5U				
2	1	C2	1000 pF, 1KV, Ceramic capacitor, Z5U				
3	1	C3	0.1 μF, 50V, Ceramic capacitor, X7R				
4	1	C4	1500 μ F, 10V, Electrolytic capacitor Low ESR, (Rubycon ZL series or equivalent)				
5	1	C5	1000 μ F, 10V, Electrolytic capacitor Low ESR, (Rubycon ZL series or equivalent)				
6	1	C6	470 μF, 10V, Electrolytic capacitor Low ESR, (Rubycon ZL series or equivalent)				
7	1	C7	470 pF, 50V, Ceramic capacitor, NPO				
8	1	C8	47 μF, 50V, Electrolytic capacitor				
9	1	C9	1000 pF, Y1 safety capacitor				
10	1	D1	1N4007GP, 1000V, 1A, glass passivated diode $t_{rr} = 2 \mu S$ (typical)				
11	1	D3	SB540, 40V 5A Schottky diode				
12	1	D4	BZX79 4.3V, 4.3V, 2%, 0.5 W, Zener diode				
13	1	D5	Zener diode option for over voltage protection				
14	1	D6	BAV20, small signal diode, 200V, 200mA				
15	1	D8	P6KE180A, TVS zener, 5W, 180V, 5%				
16	1	L1	3.3 µH, 3A, Ferrite drum core inductor, # 22 AWG magnet wire				
17	2	R1, R6	10 Ω, 1/4W, 5%, resistor				
18	1	R2	16 KΩ, 1/4W, 5%, resistor				
19	1	R3	0 Ω, 1/8W, 5%, resistor				
20	1	R4	30 Ω, 1/4W, 5%, resistor				
21	1	R5	360 Ω, 1/8W, resistor				
22	1	T1	Transformer EE19 core				
23	1	U1	TNY268P				
24	1	U2	PC817D, Optocoupler				

Table 2 - Bill of Materials



6 Transformer

6.1 Transformer Winding

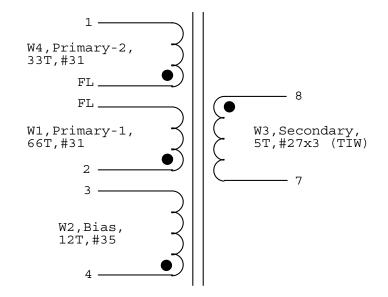


Figure 5 – Transformer Winding

Note:

1. W1 and W2 are interleaved primary winding. Both flying leads (FL) should be soldered together and wrap with tape for insulation.

6.2 Electrical Specifications

Electrical Strength	3 kV for 1 minute	
Primary Inductance (Pin 1 to Pin 2)	All windings open	1.12 mH – 1.18 mH – 1.24 mH
Resonant Frequency	All windings open	300 kHz min.
Primary Leakage Inductance	L_{12} with pins 3-8 shorted	25 μH max.

Table 3 – Transformer Electrical Parameters



6.3 Transformer Construction

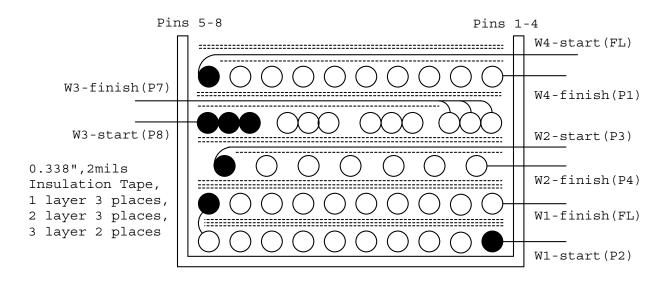


Figure 6 – Transformer Construction

6.4 Materials

ltem	Description
[1]	Core: EE19, Gapped for AL = 114 nH/T ² - 120 nH/T ² - 127 nH/T ²
[2]	Bobbin: Horizontal 8 pins
[3]	Magnet Wire: # 31 AWG
[4]	Magnet Wire: # 35 AWG
[5]	Triple Insulated Wire # 27 AWG
[6]	Tape: 3M 1298 Polyester Film (white) 0.338" x 2 mils
[7]	Tape: 3M 1298 Polyester Film (white) 0.135" x 2 mils (to wrap the core together)
[8]	Varnish

Table 4 – Transformer BOM



6.5 Winding Instructions

All windings should be wound in the forward direction.

Bobbin orientation	Place the bobbin on the winding machine with pins 1-4 on the right side and pins 5-8 on the left side.				
W1 (Primary winding-1)	Wind 66 turns in 2 layers with # 31 AWG magnet wire – first layer 33T from right to left starting from pin 2 – 3 layers of insulation tape – second layer 33T from left to right and finish as flying lead.				
Basic Insulation	3 layers of tape for insulation.				
W2 (Bias winding)	Wind 12 turns in one layer from left to right with # 35 AWG magnet wire starting temporarily from pin 6 and finish at pin 4, wind evenly across the width of the bobbin – one layer of tape – bring the starting end from pin 6 o pin 3.				
Basic Insulation	2 layers of tape for insulation.				
W3 (5V Winding)	Wind 5 turns in one layer from left to right with $\#$ 27 x 3 (trifilar) triple insulated wire, starting from pin 8 – one layer of tape – and finish at pin 7.				
Basic Insulation	2 layers of tape for insulation.				
W4 (Primary winding-2)	Wind 33 turns in one layer with # 31 AWG magnet wire from left to right starting temporarily from pin 8 and finishing at pin 1 – one layer of tape – bring the starting end from pin 8 and terminate as flying lead. Twist the flying leads (W1 and W4 FLs) together.				
Outer Insulation	2 layers of tape for insulation.				
Core Assembly	Assemble and secure core halves.				
Final Assembly	Impregnate transformer uniformly with varnish.				

6.6 Design Notes:

Power Integrations Device	TNY268P
Frequency of Operation	132 KHz
Mode	Continuous/ discontinuous
Peak Current	0.55 A
Reflected Voltage (Secondary to Primary)	109 V
Maximum AC Input Voltage	301 Vac
Minimum AC Input Voltage	85 Vac

 Table 5 – Power Supply Design Parameters



7 Transformer Design Spread Sheet

	lei Design spi	cau She	GL	
ACDC_TNY-				
II_Rev1_1_03270				
1				ACDC_TNYII_Rev1_1_032701.xls:
Copyright Power				TinySwitch-II
Integrations Inc.				Continuous/Discontinuous Flyback
2001	INPUT INFO	OUTPUT	UNIT	Transformer Design Spreadsheet
		OUIPUI	UNIT	Transformer Design Spreadsheet
ENTER APPLICA	IION			
VARIABLES				Customer
VACMIN	85		Volts	Minimum AC Input Voltage
VACMAX	301		Volts	Maximum AC Input Voltage
fL	60		Hertz	AC Mains Frequency
VO	5		Volts	Output Voltage
PO	15		Watts	Output Power
	0.79		i i dillo	Efficiency Estimate
n T				-
Z	0.5			Loss Allocation Factor
				Bridge Rectifier Conduction Time
tC	3		mSeconds	s Estimate
CIN	220		uFarads	Input Filter Capacitor
•				
ENTER				
TinySwitch-II				
VARIABLES				
TNY-II	TNY268		Universa	I 115 Doubled/230V
Chosen Device	TNY268	Power Out	15W	23W
ILIMITMIN		0.512	Amps	TINYSwitch Minimum Current Limit
ILIMITMAX			•	
		0.588	Amps	TINYSwitch Maximum Current Limit
fS		132000	Hertz	TINYSwitch Switching Frequency
				TINYSwitch Minimum Switching
fSmin		120000	Hertz	Frequency (inc. jitter)
				TINYSwitch Maximum Switching
fSmax		144000	Hertz	Frequency (inc. jitter)
VOR	109	144000		
VUR	109		Volts	Reflected Output Voltage
				TINYSwitch on-state Drain to Source
VDS	10		Volts	Voltage
				Output Winding Diode Forward Voltage
VD	0.5		Volts	Drop
				Ripple to Peak Current Ratio
KP		0.74		(0.6 <krp<1.0:1.0<kdp<6.0)< td=""></krp<1.0:1.0<kdp<6.0)<>
-				
0 T	10			
Core Type	ee19			
Core	EE1	9	P/N:	PC40EE19-Z
	EE19_B	0		
Bobbin	BBI		P/N:	BE-19-118CPH
AE		0.23	cm^2	Core Effective Cross Sectional Area
LE		3.94	cm	Core Effective Path Length
AL		1250	nH/T^2	Ungapped Core Effective Inductance
BW		9	mm	Bobbin Physical Winding Width
		-		Safety Margin Width (Half the Primary to
Μ	0		mm	Secondary Creepage Distance)
141	0			coordary croopage Distance



L NS	3 5			Number of Primary Layers Number of Secondary Turns
DC INPUT VOLTAGE PARAMETERS				
VMIN VMAX		116 426	Volts Volts	Minimum DC Input Voltage Maximum DC Input Voltage
DMAX IAVG IP IR IRMS		0.51 0.16 0.51 0.38 0.24	Amps Amps Amps Amps	Maximum Duty Cycle Average Primary Current Minimum Peak Primary Current Primary Ripple Current Primary RMS Current
LP NP		1159 99	uHenries	Primary Inductance Primary Winding Number of Turns
ALG BM		118 2989	nH/T^2 Gauss	Gapped Core Effective Inductance Flux Density, IP (BP<3000) AC Flux Density for Core Loss Curves
BAC ur		963 1704	Gauss	(0.5 X Peak to Peak) Relative Permeability of Ungapped Core
LG BWE		0.22 27	mm mm	Gap Length (Lg > 0.1 mm) Effective Bobbin Width
OD		0.27	mm	Maximum Primary Wire Diameter including insulation Estimated Total Insulation Thickness (= 2
INS DIA		0.05 0.22	mm mm	* film thickness) Bare conductor diameter Primary Wire Gauge (Rounded to next
AWG		32	AWG	smaller standard AWG value) Bare conductor effective area in circular
СМ		64	Cmils	mils Primary Winding Current Capacity (200 <
СМА		264	Cmils/Amp	oCMA < 500)
Lumped parameters			_	
ISP		10.15	Amps	Peak Secondary Current
ISRMS IO		4.74 3.00	Amps Amps	Secondary RMS Current Power Supply Output Current
IRIPPLE		3.67	Amps	Output Capacitor RMS Ripple Current Secondary Bare Conductor minimum
CMS		948	Cmils	circular mils Secondary Wire Gauge (Rounded up to
AWGS		20	AWG	next larger standard AWG value) Secondary Minimum Bare Conductor
DIAS		0.81	mm	Diameter Ó Secondary Maximum Outside Diameter
ODS		1.80	mm	for Triple Insulated Wire



INSS	0.49	mm	Maximum Secondary Insulation Wall Thickness	
VDRAIN	675 Volts	Maximum Drain Voltage Estimate (Includes Effect of Leakage Inductance Output Rectifier Maximum Peak Inverse		
PIVS	26	Volts	Voltage	

8 Performance Data

The measurements were taken for the power supply in two ways:

- 1) As a stand-alone unit, and
- 2) In a PC power supply, operating in standby mode

A comparison was made against the original standby power supply (*TOP244P* design) in the PC power supply.

The measurements as stand-alone unit are given in the table below. 13V output is not loaded.



8.1 Light Load Input and Output Power Comparison

These measurements were taken of the whole PSU, in standby mode. A comparison is made with the original standby design, against the TinySwitch-II design. For the measurements, the original standby supply was removed and the TinySwitch-II prototype was wired in. In both cases, the standby supply was powering the primary-side 13V circuits in the PSU.

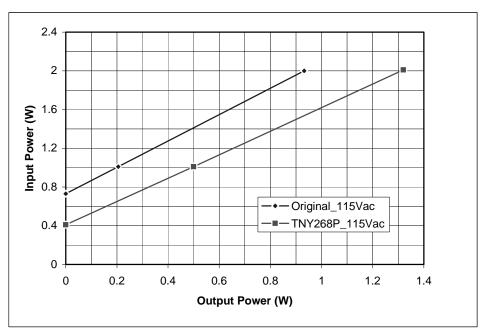


Figure 7 – Input vs. Output power at 115 Vac

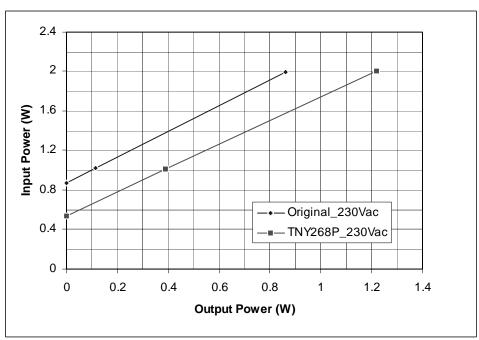


Figure 8 – Input vs. Output power at 230 Vac



8.2 Efficiency comparison, standalone

The efficiency of the TNY268P design is % higher than the TOP244P design, especially at light load.

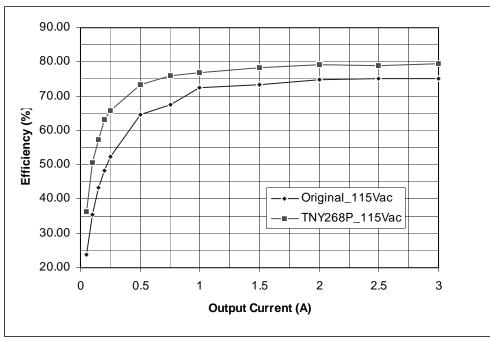


Figure 9 - Efficiency versus output current at 115 Vac

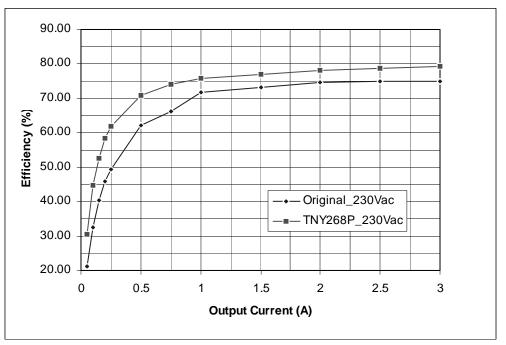


Figure 10 – Efficiency versus output current at 230 Vac



9 Output Ripple Measurements

9.1 Ripple Measurement Technique

For DC output ripple measurements, a modified oscilloscope test probe must be utilized in order to reduce spurious signals due to pickup. Details of the probe modification are provided in Figure 11 and Figure 12.

The 5125BA probe adapter is affixed with two capacitors tied in parallel across the probe tip. The capacitors include one (1) 0.1 μ F/50 V ceramic type and one (1) 1.0 μ F/50 V aluminum electrolytic. The aluminum electrolytic type capacitor is polarized, so proper polarity across DC outputs must be maintained (see below).

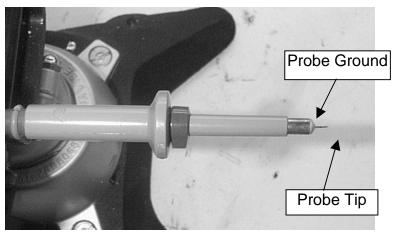


Figure 11 – Oscilloscope Probe Prepared for Ripple Measurement. (End Cap and Ground Lead Removed)

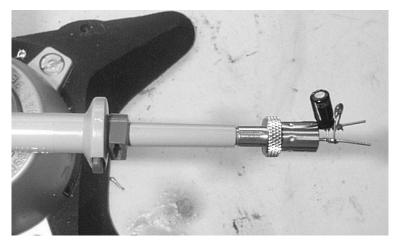


Figure 12 - Oscilloscope Probe with Probe Master 5125BA BNC Adapter

(Modified with wires for probe ground for ripple measurement, and two parallel decoupling capacitors added).



9.2 Output Voltage Ripple

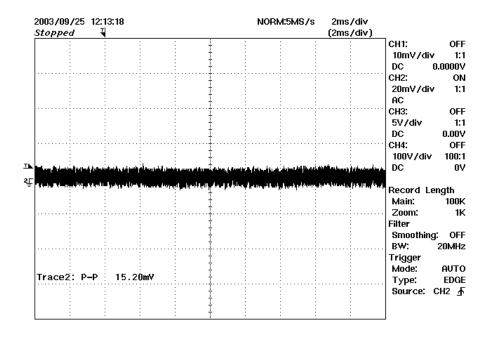


Figure 13 – 5V Output Voltage Ripple at V_{IN} = 115 Vac, I_{5V} = 3 A

10 Revision History

Date	Author	Revision	Description & changes	Reviewed
February 4, 2004	MJ	1.0	Initial release	VC/AM



Notes



For the latest updates, visit our Web site: www.powerint.com

Power Integrations reserves the right to make changes to its products at any time to improve reliability or manufacturability. Power Integrations does not assume any liability arising from the use of any device or circuit described herein, nor does it convey any license under its patent rights or the rights of others.

The products and applications illustrated herein (including circuits external to the products and transformer construction) may be covered by one or more U.S. and foreign patents or potentially by pending U.S. and foreign patent applications assigned to Power Integrations. A complete list of Power Integrations' patents may be found at www.powerint.com.

The PI Logo, TOPSwitch, TinySwitch, LinkSwitch, and EcoSmart are registered trademarks of Power Integrations, Inc. **PI Expert** and **DPA-Switch** are trademarks of Power Integrations, Inc. © Copyright 2003, Power Integrations, Inc.

WORLD HEADQUARTERS **NORTH AMERICA - WEST**

Power Integrations, Inc. 5245 Hellyer Avenue San Jose, CA 95138 USA. Main: +1•408•414•9200 Customer Service: Phone: +1•408•414•9665 Fax: +1•408•414•9765

CHINA

Power Integrations International Holdings, Inc. Rm# 1705, Bao Hua Bldg. 1016 Hua Qiang Bei Lu Shenzhen Guangdong, 518031 Phone: +86•755•367•5143 Fax: +86•755•377•9610

APPLICATIONS HOTLINE World Wide +1•408•414•9660

NORTH AMERICA - EAST & SOUTH AMERICA Power Integrations, Inc. Eastern Area Sales Office 1343 Canton Road, Suite C1 Marietta, GA 30066 USA Phone: +1•770•424•5152 Fax: +1•770•424•6567

KOREA

Power Integrations International Holdings, Inc. Rm# 402, Handuk Building, 649-4 Yeoksam-Dong, Kangnam-Gu, Seoul, Korea Phone: +82•2•568•7520 Fax: +82•2•568•7474

APPLICATIONS FAX World Wide +1•408•414•9760

EUROPE & AFRICA Power Integrations (Europe) Ltd. Centennial Court Easthampstead Road Bracknell

Berkshire RG12 1YQ, United Kingdom Phone: +44•1344•462•301 Fax: +44•1344•311•732

JAPAN

Power Integrations, K.K. Keihin-Tatemono 1st Bldg. 12-20 Shin-Yokohama 2-Chome. Kohoku-ku, Yokohama-shi, Kanagawa 222, Japan Phone: +81•45•471•1021 Fax: +81•45•471•3717

TAIWAN

Power Integrations International Holdings, Inc. 2F, #508, Chung Hsiao E. Rd., Sec. 5, Taipei 105, Taiwan Phone: +886•2•2727•1221 Fax: +886•2•2727•1223

INDIA (Technical Support) Innovatech

#1, 8th Main Road Vasanthnagar Bangalore, India 560052 Phone: +91•80•226•6023 Fax: +91•80•228•9727

